

3.5X2.8mm SURFACE MOUNT SMD CHIP LED



ATTENTION

OBSERVE PRECAUTIONS FOR HANDLING **ELECTROSTATIC** DISCHARGE SENSITIVE **DEVICES**

Part Number: AAAF3528QBFSEJ3ZGW

Blue Hyper Red Green

Features

- Outstanding material efficiency.
- Low power consumption.
- Can produce any color in visible spectrum, including white light.
- Suitable for all SMT assembly and solder process.
- Available on tape and reel.
- Package: 1500pcs / reel .
- Moisture sensitivity level : level 4.
- RoHS compliant.

Description

The Blue source color devices are made with InGaN Light Emitting Diode.

The Hyper Red device is based on light emitting diode chip made from AlGaInP.

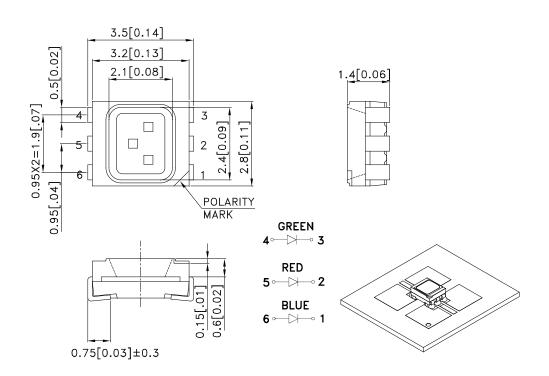
The Green source color devices are made with InGaN on Sapphire Light Emitting Diode.

Static electricity and surge damage the LEDS.

It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

Package Dimensions



SPEC NO: DSAI9804

APPROVED: WYNEC

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.2(0.008") unless otherwise noted.
- 3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

 4. The device has a single mounting surface. The device must be mounted according to the specifications.

REV NO: V.6A

CHECKED: Allen Liu

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Selection Guide

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
		,	Min.	Тур.	201/2
AAAF3528QBFSEJ3ZGW	Blue (InGaN)		120	250	120°
		White Diffused	*120	*250	
	Hyper Red (AlGaInP)		900	1700	
			*300	*550	
	Green (InGaN)		480	900	
			*400	*550	

- $1. \theta 1/2$ is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.		Max.	Units	Test Conditions
λpeak	Peak Wavelength	Blue Hyper Red Green	461 640 515	*460 *640 *515		nm	IF=20mA
λD [1]	Dominant Wavelength	Blue Hyper Red Green	465 625 525	*465 *625 *525		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Blue Hyper Red Green	2	25 25 30		nm	IF=20mA
С	Capacitance	Blue Hyper Red Green	2	00 27 15		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Blue Hyper Red Green	2	i.3 i.2 i.3	4 2.8 4.1	V	IF=20mA
lr	Reverse Current	Blue Hyper Red Green			50 10 50	uA	VR=5V

Absolute Maximum Ratings at TA=25°C

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Parameter	Blue	Hyper Red	Green	Units			
Power dissipation	120	140	123	mW			
DC Forward Current	30	50	30	mA			
Peak Forward Current [1]	150	150	150	mA			
Reverse Voltage	5 V						
Operating Temperature	-40°C To +85°C						
Storage Temperature	-40°C To +85°C						

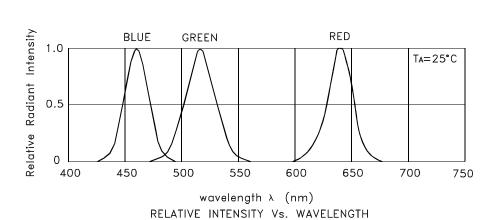
1. 1/10 Duty Cycle, 0.1ms Pulse Width.

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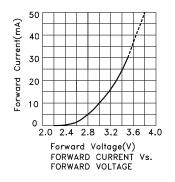
^{2.} Luminous intensity/ luminous Flux: +/-15%.

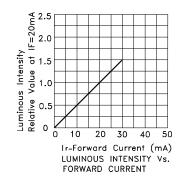
*Luminous intensity value is traceable to the CIE127-2007 compliant national standards

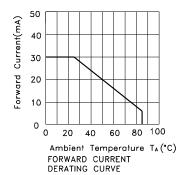
^{1.} Wavelength: +/-1nm.
2. Forward Voltage: +/-0.1V.
*Wavelength value is traceable to the CIE127-2007 compliant national standards.

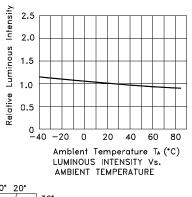


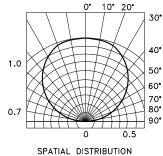
AAAF3528QBFSEJ3ZGW Blue









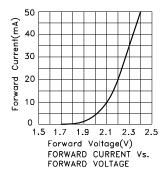


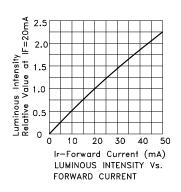
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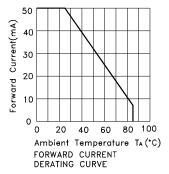
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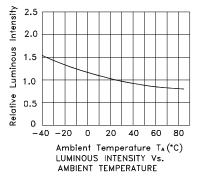
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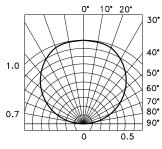
Hyper Red









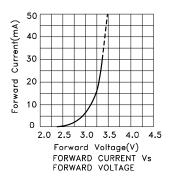


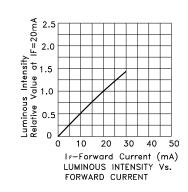
SPATIAL DISTRIBUTION

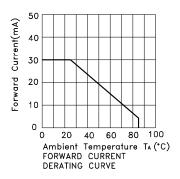
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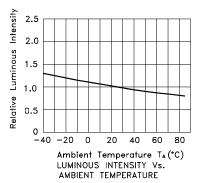
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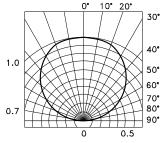
Green











SPATIAL DISTRIBUTION

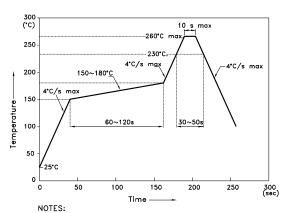
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Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



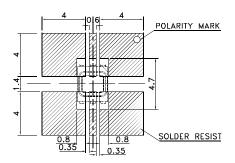
- NOTES:

 1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

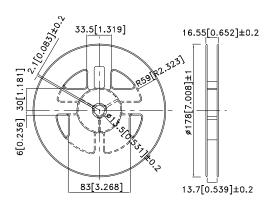
 3.Number of reflow process shall be 2 times or less.

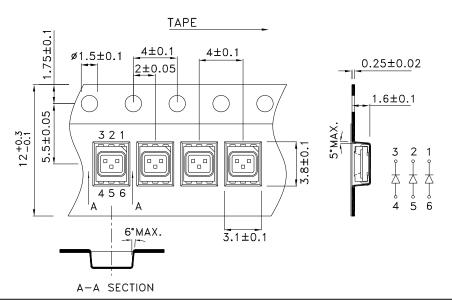
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



Tape Dimensions (Units: mm)

Reel Dimension



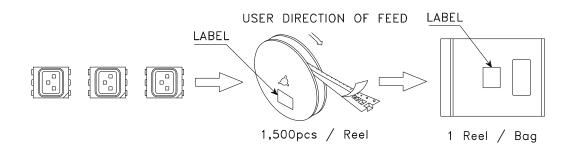


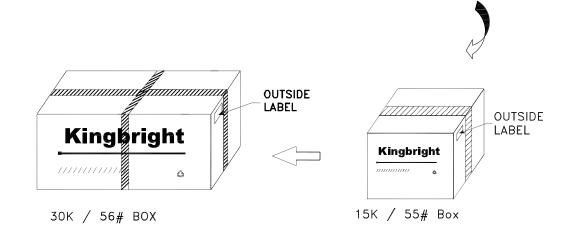
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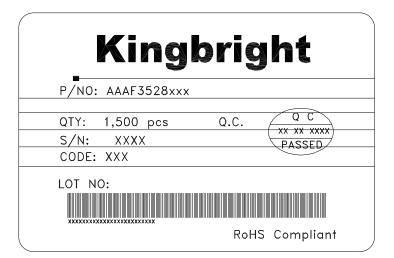
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PACKING & LABEL SPECIFICATIONS

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